4-Pin Half-Pitch Mini-Flat Phototransistor Optocouplers

Description

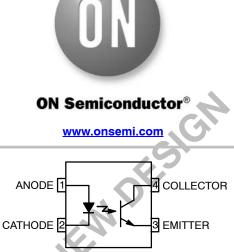
The HMHA281 and HMHA2801 series devices consist of a gallium arsenide infrared emitting diode driving a silicon phototransistor in a compact 4-pin mini-flat package. The lead pitch is 1.27 mm.

Features

- Compact 4–Pin Package
 - 2.4 mm Maximum Standoff Height
 - Half-Pitch Leads for Optimum Board Space Savings
- Current Transfer Ratio:
 - HMHA281: 50% to 600%
 - HMHA2801: 80% to 600%
 - ◆ HMHA2801A: 80% to 160%
 - ◆ HMHA2801B: 130% to 260%
 - HMHA2801C: 200% to 400%
- Safety and Regulatory Approvals:
 - ◆ UL1577, 3.750 VAC_{RMS} for 1 Minute
- DIN-EN/IEC60747-5-5, 565 V Peak Working Insulation Voltage
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Digital Logic Inputs
- Microprocessor Inputs
- Power Supply Monitor
- Twisted Pair Line Receiver
- Telephone Line Receiver







CASE 100AL

MARKING DIAGRAM



- = ON Semiconductor Logo ON
- 281 = Device Number
- V = DIN EN/IEC60747-5-5 Option (only appears on component ordered with this option)
- = One-Digit Year Code, e.g., "5" х
- YΥ = Digit Work Week, Ranging from "01" to "53"
- = Assembly Package Code M1

ORDERING INFORMATION

See detailed ordering and shipping information on page 7 of this data sheet.

Table 1. SAFETY AND INSULATION RATINGS (As per DIN EN/IEC 60747-5-5, this optocoupler is suitable for "safe electrical insulation" only within the safety limit data. Compliance with the safety ratings shall be ensured by means of protective circuits.)

Parameter	Characteristics	
Installation Classifications per DIN VDE 0110/1.89 Table 1, For Rated Mains Voltage	ation Classifications per DIN VDE 0110/1.89 Table 1, For Rated Mains Voltage $< 150 V_{RMS}$	
	< 300 V _{RMS}	I–III
Climatic Classification	55/100/21	
Pollution Degree (DIN VDE 0110/1.89)	2	
Comparative Tracking Index		175

Symbol	Parameter	Value	Unit
V _{PR}	Input-to-Output Test Voltage, Method A, V_{IORM} x 1.6 = V_{PR} , Type and Sample Test with t_m = 10 s, Partial Discharge < 5 pC	904	V _{peak}
	Input-to-Output Test Voltage, Method B, V _{IORM} x 1.875 = V _{PR} , 100% Production Test with t_m = 1 s, Partial Discharge < 5 pC	1060	V _{peak}
V _{IORM}	Maximum Working Insulation Voltage	565	V _{peak}
VIOTM	Highest Allowable Over-Voltage	4000	V _{peak}
	External Creepage	≥5	mm
	External Clearance	≥5	mm
DTI	Distance Through Insulation (Insulation Thickness)	≥0.4	mm
Τ _S	Case Temperature (Note 1)	150	°C
I _{S, INPUT}	Input Current (Note 1)	200	mA
P _{S, OUTPUT}	Output Power (Note 1)	300	mW
R _{IO}	Insulation Resistance at T_S , V_{IO} = 500 V (Note 1)	>10 ⁹	Ω

1. Safety limit values - maximum values allowed in the event of a failure.

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise specified)

Symbol	Parameter	Value	Unit
TAL PACKA	AGE		
T _{STG}	Storage Temperature	–55 to +125	°C
T _{OPR}	Operating Temperature	–55 to +100	°C
TJ	Junction Temperature	-40 to +125	°C
PD	Total Device Power Dissipation @ $T_A = 25^{\circ}C$	210	mW
	Derate Above 25°C	2.1	mW/°C

I _{F (avg)}	Continuous Forward Current	50	mA
I _{F (pk)}	Peak Forward Current (1 μ s pulse, 300 pps)	1	А
V _R	Reverse Input Voltage	6	V
PD	LED Power Dissipation @ $T_A = 25^{\circ}C$	60	mW
	Derate Above 25°C	0.6	mW/°C

DETECTOR

Ι _C	Continuous Collector Current	50	mA
V _{CEO}	Collector-Emitter Voltage	80	V
V _{ECO}	Emitter-Collector Voltage	7	V
PD	Detector Power Dissipation @ $T_A = 25^{\circ}C$	150	mW
	Derate Above 25°C	1.5	mW/°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

ELECTRICAL CHARACTERISTICS (T_A = 25° C)

Symbol	Parameter	Test Conditions	Device	Min	Тур	Max	Unit
INDIVIDUA	L COMPONENT CHARACTERISTICS						

Emitter

V _F	Forward Voltage	l _F = 10 mA	All	1.0	-	1.3	V
I _R	Reverse Current	V _R = 5 V	All	-	-	5	μΑ
Detector	Detector						
BV_{CEO}	Breakdown Voltage Collector to Emitter	I _C = 0.5 mA, I _F = 0	All	80	-	-	V

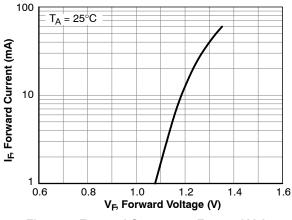
DICEO	Breakdown Volkago obliotion to Ennitor	10 = 0.0 m/ (, 1F = 0	7 41				•
BV _{ECO}	Emitter to Collector	$I_{E} = 100 \ \mu A, \ I_{F} = 0$	All	7	-	-	
I _{CEO}	Collector Dark Current	$V_{CE} = 80 \text{ V}, I_F = 0$	All	-	-	100	nA
C _{CE}	Capacitance	$V_{CE} = 0 V$, f = 1 MHz	All	-	10	-	pF

TRANSFER CHARACTERISTICS

CTR	DC Current Transfer Ratio	I _F = 5 mA, V _{CE} = 5 V	HMHA281	50	-	600	%	
			HMHA2801	80	-	600		
			HMHA2801A	80	-	160		
			HMHA2801B	130	-	260		
			HMHA2801C	200	-	400		
V _{CE (SAT)}	Saturation Voltage	I _F = 8 mA, I _C = 2.4 mA	HMHA281	-	-	0.4	V	
		I _F = 10 mA, I _C = 2 mA	HMHA2801, HMHA2801A, HMHA2801B, HMHA2801C	-	-	0.3		
t _r	Rise Time (Non-Saturated)	I_{C} = 2 mA, V_{CE} = 5 V, R_{L} = 100 Ω	All	-	3	-	μs	
t _f	Fall Time (Non-Saturated)	I_{C} = 2 mA, V_{CE} = 5 V, R_{L} = 100 Ω	All	-	3	-		
ISOLATION	ISOLATION CHARACTERISTICS							
V _{ISO}	Steady State Isolation Voltage	1 Minute	All	3750	-	-	VAC _{RMS}	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS



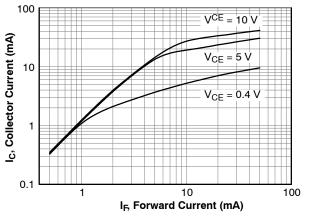


Figure 1. Forward Current vs. Forward Voltage

Figure 2. Collector Current vs. Forward Current

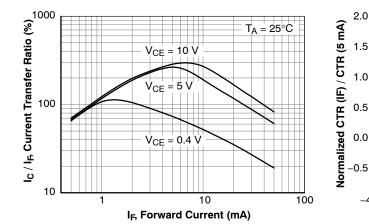


Figure 3. Current Transfer Ratio vs. Forward Current

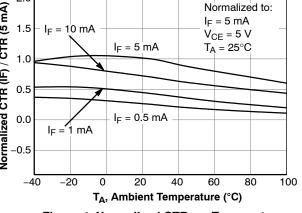


Figure 4. Normalized CTR vs. Temperature

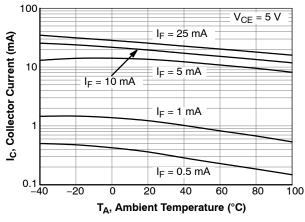
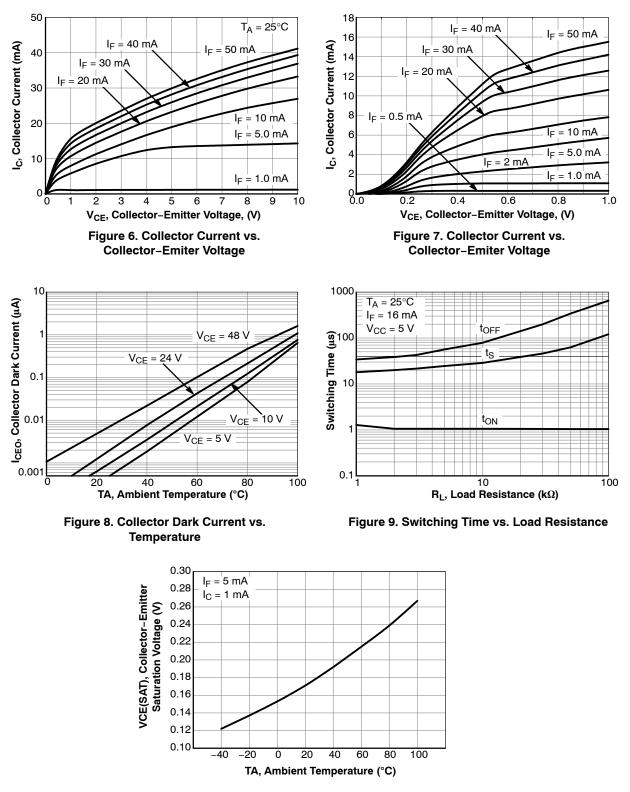


Figure 5. Collector Current vs. Temperature

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)





REFLOW PROFILE

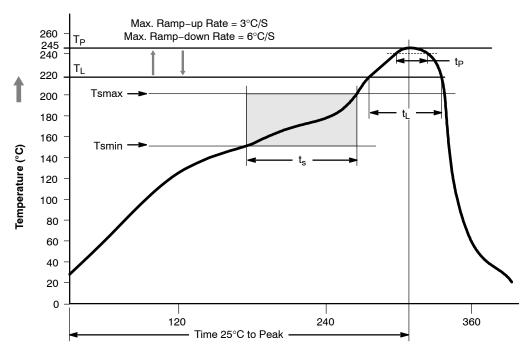


Figure 11. Reflow Profile

Profile Freature	Pb-Free Assembly Profile
Temperature Minimum (Tsmin)	150°C
Temperature Maximum (Tsmax)	200°C
Time (t _S) from (Tsmin to Tsmax)	60 – 120 seconds
Ramp-up Rate (t _L to t _P)	3°C / second maximum
Liquidous Temperature (T _L)	217°C
Time (t _L) Maintained Above (T _L)	60 – 150 seconds
Peak Body Package Temperature	245°C +0°C / –5°C
Time (t _P) within 5°C of 245°C	30 seconds
Ramp-down Rate (T _P to T _L)	6°C / second maximum
Time 25°C to Peak Temperature	8 minutes maximum

ORDERING INFORMATION

Part Number	Package	Shipping [†]
HMHA2801	Half Pitch Mini-Flat 4-Pin	100 Units / Tube
HMHA2801R2	Half Pitch Mini-Flat 4-Pin	2500 / Tape & Reel
HMHA2801V	Half Pitch Mini-Flat 4-Pin, DIN EN/IEC60747-5-5 Option	100 Units / Tube
HMHA2801R2V	Half Pitch Mini-Flat 4-Pin, DIN EN/IEC60747-5-5 Option	2500 / Tape & Reel

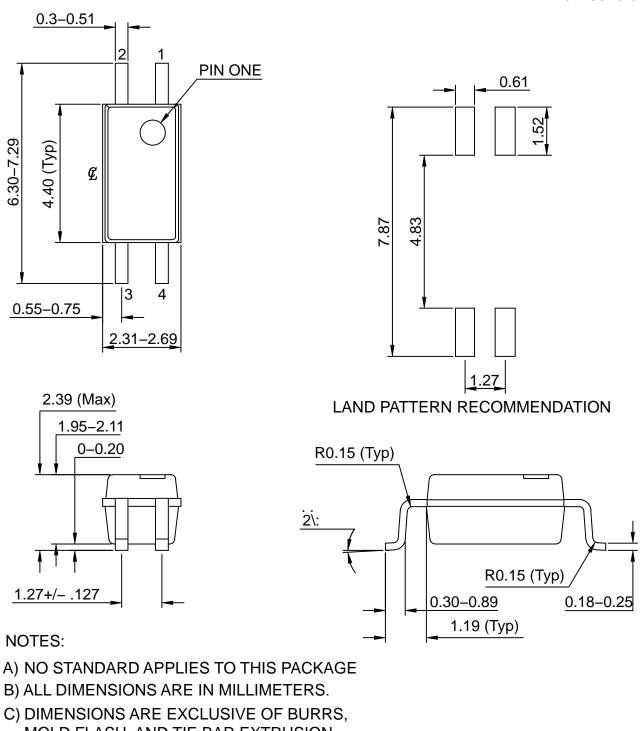
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS



MFP4 2.5X4.4, 1.27P CASE 100AL ISSUE O

DATE 31 AUG 2016



MOLD FLASH, AND TIE BAR EXTRUSION

DOCUMENT NUMBER:	98AON13485G	Electronic versions are uncontrolled exc	
STATUS:	ON SEMICONDUCTOR STANDARD	accessed directly from the Document Reposi versions are uncontrolled except when	
NEW STANDARD:		"CONTROLLED COPY" in red.	-
DESCRIPTION:	MFP4 2.5X4.4, 1.27P	PAG	E 1 OF 2



DOCUMENT NUMBER: 98AON13485G

PAGE 2 OF 2

ISSUE	REVISION	DATE
0	RELEASED FOR PRODUCTION FROM FAIRCHILD MFP04A TO ON SEMICONDUCTOR. REQ. BY B. MARQUIS.	31 AUG 2016

ON Semiconductor and with a registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other application in which the BSCILLC product call create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use payers that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunit/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

ON Semiconductor and 💷 are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdl/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typical" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303–675–2176 or 800–344–3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support:

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit Phone: 421 33 790 2910

For additional information, please contact your local

Sales Representative